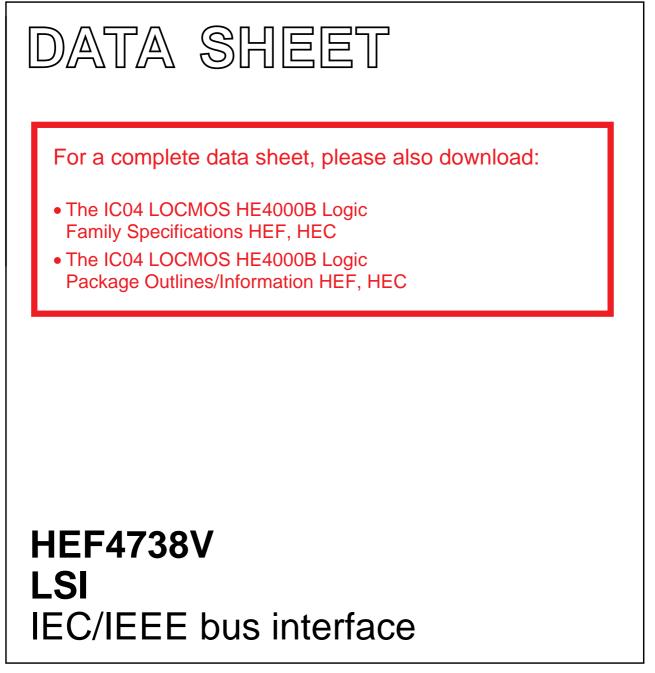
# INTEGRATED CIRCUITS



Product specification File under Integrated Circuits, IC04 January 1995



## HEF4738V LSI

#### DESCRIPTION

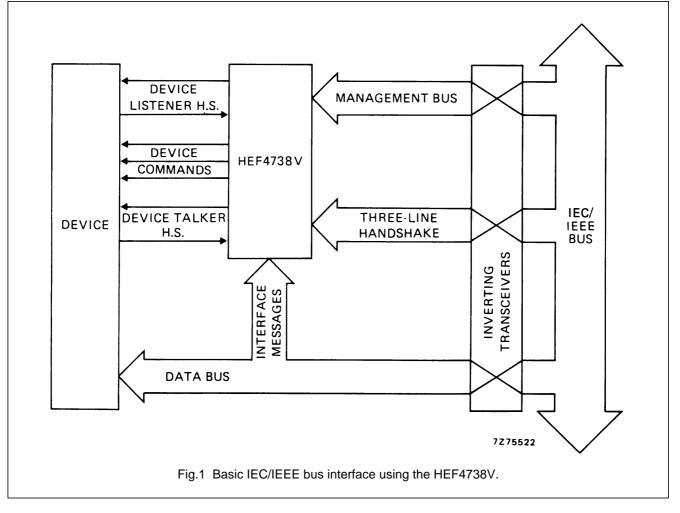
The HEF4738V is an implementation of the IEC-bus as described in IEC report 66 CO 22 (interface system for programmable measuring apparatus) as well as in IEEE standard 488-1975 (standard digital interface for programmable instrumentation).

Together with bus-drivers, level converters and multiplexers it is suitable for connecting electronic programmable and non-programmable equipment to an IEC/IEEE interface bus.

All inputs have standard HE4000B family levels.

In the circuit the following standard interface functions are incorporated:

- Complete source handshake (subset SH1)
- Complete acceptor handshake (subset AH1)
- Basic talker with serial poll and talk-only mode (when It = LOW, subset T1; It = HIGH, subset T5)
- Basic listener with listen-only mode (when It = LOW, subset L1; It = HIGH, subset L3)
- Complete service request (subset SR1)
- Complete remote local (subset RL1)
- Remote parallel poll configuration (subset PP1)
- Complete device clear (subset DC1)
- Complete device trigger (subset DT1)
- Some controller facilities



#### SUPPLY VOLTAGE

RATING	RECOMMENDED OPERATING
–0,5 to 18	4,5 to 12,5 V

#### January 1995

### FAMILY DATA, I<sub>DD</sub> LIMITS category LSI

See Family Specifications

The inputs IRFD, IDAC, IDAV, IIFC, IREN, IATN, IIDY and IDIO1 to IDIO7 must be connected via an inverting TTL to LOCMOS level converter to the respective bus lines: NRFD, NDAC, DAV, IFC, REN, ATN, IDY and DIO1 to DIO7.

The outputs ORFD, ODAC, ODAV and OSRQ can drive one standard TTL load and are suitable for driving NRFD, NDAC, DAV and SRQ via an inverting bus-driver circuit. The parallel poll outputs OP1, OP2, OP3 and OPP can also drive one standard TTL load. Outputs OP1, OP2 and OP3 are connected to flip-flops, which store the attendant bits P1, P2 and P3 of the last PPE message. OP1, OP2 and OP3 have to be decoded externally and multiplexed to the DIO-lines when OPP is LOW.

All other output stages are standard HE4000B family. Most of the functions in the IEC/IEEE interface IC are realized with synchronous sequential logic, which is driven from the clock input CP. HIGH to LOW transitions are used to synchronize input signals and LOW to HIGH transitions trigger the internal flip-flops. In order to meet the IEC/IEEE timing specifications, the maximum clock frequency is 2 MHz. The maximum data transfer is then

200 kbytes/second.

Input Irdy (not ready for next message) and output Odvd (data valid device) are intended for a two-wire handshake procedure between the acceptor function in the IC and the data input of the device (instrument to be connected to the interface system). The procedure is made so, that if the device reacts fast enough, the handshake procedure can be omitted by interconnecting Odvd and Irdy. The conditions to be fulfilled by the device are:

- The device must be able to accept a data byte within one clock period after dvd goes HIGH under all conditions.
- The device must be ready to process a data byte within two clock periods plus the minimum settling time of the talker devices under all conditions.

Input Inba (not new byte available) and output Odcd (don't change data) are intended for a two-wire handshake procedure with the source function in the IC and the data output of the device (instrument). The procedure is so made that if the device reacts fast enough the handshake procedure can be omitted by interconnecting Odcd and Inba. The conditions to be fulfilled by the device are:

- The device must be able to set a new data byte on the bus within one clock period after dcd goes LOW under all conditions.
- The device must be able to have the next data byte available within seven clock periods under all conditions.

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Input Isr and output Ored should be connected to an external parallel-in/serial-out (when Ored is HIGH parallel-in, when LOW serial-out) shift register, which must be connected to the clock CP and must trigger on the LOW to HIGH transitions. The data on the parallel inputs of this external shift register are loaded in parallel and shifted-out via input Isr into an internal shift register. The eleven serial input signals are in the order of shifting: A5, A4, A3, A2, A1, ton, Ion, It, rsv, rtl and ist.

Signals A5, A4, A3, A2 and A1 represent the device talker and listener address. When signal It (either listener or talker) is HIGH, a listener addressing sets the talker to the idle state and a talker addressing sets the listener to the idle state (subset T5 and L3). With It LOW, the device can be addressed to be a listener and a talker. Because of the serial input procedure, all these input signals arrive in the interface functions of the IC between 16 and 32 clock cycles.

The signals ton, lon, rsv, rtl and ist are standard IEC/IEEE inputs. When using ton or lon no controller action is possible.

The output Oclr or Otrg is HIGH for one clock pulse if DCAS (device clear active state) or DTAS (device trigger active state) respectively is active.

The output Oloc is HIGH when LOCS (local state) or LWLS (local with lock-out state) is active. Output OSRQ is HIGH when the rsv signal is read from the external shift register and the SRQS (request service state) is active. After this request has been answered by a serial poll, ORQS is HIGH in the APRS (affirmative poll response state). The inverted signal on ORQS must be multiplexed to bus-line DIO7, together with the status byte of the other DIO lines, when output Osp is HIGH in the SPAS (serial poll active state).

When the device is in the SPAS state the signal rsv may be removed (can be checked on ORQS). N.B.: When the interface has asked for service via rsv and is addressed as talker in the serial poll mode, a handshake must be initialized by the device via Inba.

Input Icats and output Otct are intended for use of this IC in a controller. When Icats is HIGH, the source handshake function will exit SIDS and SIWS and enter respectively SGNS and SWNS. When the controller function is not used, the input Icats must be connected to  $V_{SS}$ . Output Otct is HIGH if the tct message is sent over the interface and the ACDS state is active. A HIGH on input Ipon sets each function to its initial state. This level can be set to LOW after the IC has received 32 clock pulses at stabilized supply voltage.

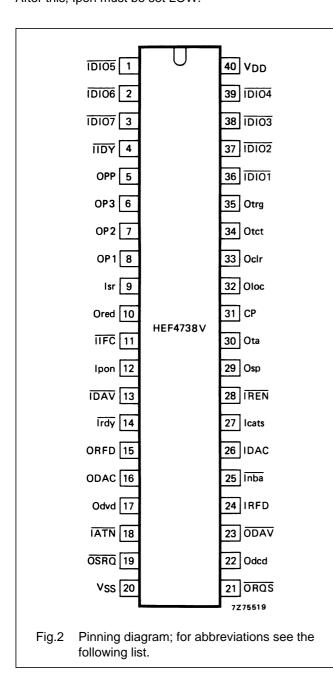
**HEF4738V** 

LSI

## IEC/IEEE bus interface

#### Note

After power-on the input Ipon must stay LOW for at least 32 clock pulses, then HIGH for 32 clock pulses in order to force the function to its initial state. After this, Ipon must be set LOW.



HEF4738VP(N): 40-lead DIL; plastic (SOT129-1) (): Package Designator North America

### Input pins

1,2,3,36,	= ID101 to 7:	input DIO
37, 38, 39 4 = IIDY		input IDY not
9 = Isr (note 1)		input shift register
$11 = \overline{IIFC}$		input IFC not
12 = Ipon		input pon
$13 = \overline{IDAV}$		input DAV not
14 = Irdy		input rdy not
18 = IATN		input ATN not
24 = IRFD		input RFD
25 = Inba		input nba not
26 = IDAC		input DAC
27 = lcats		inputs cats
28 = IREN		input REN not
31 = CP		clock pulse input
Output pins		
5 = OPP		output PP
8,7,6, = OP1 to 0	DP3	output P1 to P3
10 = Ored		output red
15 = ORFD		output RFD
16 = ODAC		output DAC
17 = Odvd		output dvd
19 = OSRQ		output SRQ not
21 = ORQS		output RQS not
22 = Odcd		output dcd
$23 = \overline{ODAV}$		output DAV not
29 = Osp		output sp
30 = Ota		output ta
32 = Oloc		output loc
33 = Oclr		output clr
34 = Otct		output tct
35 = Otrg		output trg
Supply pins		
20 = V <sub>SS</sub> :	more nega	ative supply line

20 = V <sub>SS</sub> :	more negative supply line
40 = V <sub>DD</sub> :	more positive supply line

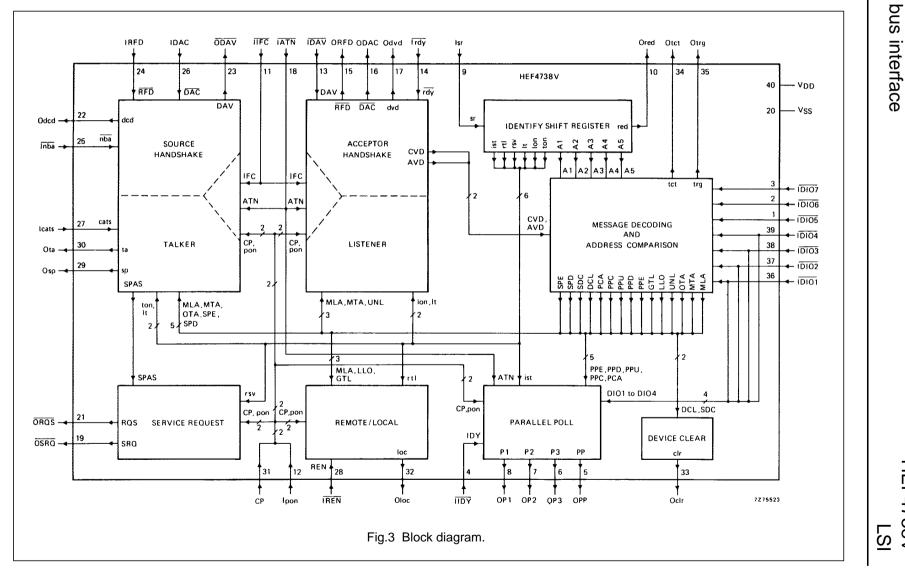
### Note

1. Isr is serial input for signals A5, A4, A3, A2, A1, ton, Ion, It, rsv, rtl and ist.

### Note

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Because the circuit uses positive logic and the bus uses negative logic, all inputs and outputs to the bus must be inverted. For that reason, all terminals that are working with the bus have mnemonics which are the inverted ones of those on the bus.



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Product specification

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# IEC/IEEE bus interface

### LIST OF USED ABBREVIATIONS

A1 to A5	address	PPE	parallel poll enable
ACDS	acceptor data state	PPU	parallel poll unconfigure
APRS	affirmative poll response state	rdy	ready for next message
ATN	attention	red	ready for next shift cycle
AVD	address valid	REN	remote enable
cats	controller active or transfer state	RFD	ready for data
clr	device clear	RQS	requested service
CVD	command valid	rsv	request for service
DAC	data accepted	rtl	return to local
DAV	data valid	SDC	selected device clear
DCAS	device clear active state	SGNS	source generate state
dcd	don't change data	SIDS	source idle state
DCL	device clear	SIWS	source idle wait state
DIO	data input output	sp	serial poll
DTAS	device trigger active state	SPAS	serial poll active state
dvd	data valid device	SPD	serial poll disable
EOI	end of output/identify	SPE	serial poll enable
GTL	go to local	sr	shift register
IDY	identify	SRQ	service request
IFC	interface clear	SRQS	request service state
ist	individual status	SWNS	source wait for new cycle state
LLO	local lock-out	ta	talker active
loc	local	tct	talk control
LOCS	local state	ton	talk only
lon	listen only	trg	trigger
lt	decides whether the device can only be	UNL	unlisten
	listener/talker or listener and talker		
	simultaneously		
LWLS	local with lock-out state		

MLA

MTA

nba

NRFD

NDAC

P1 to P3

OTA

PCA

pon

PΡ

PPC

PPD

my listen address

new byte available

not ready for data

not data accepted

other talk address

power on

parallel response messages

parallel poll message enable

parallel poll configure

parallel poll disable

parallel poll configure accepted

my talk address

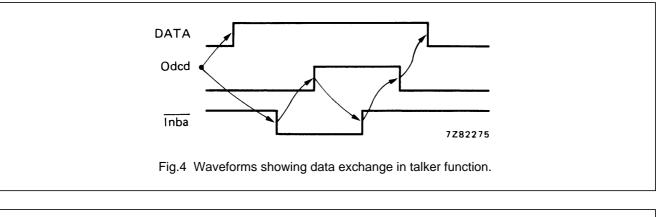
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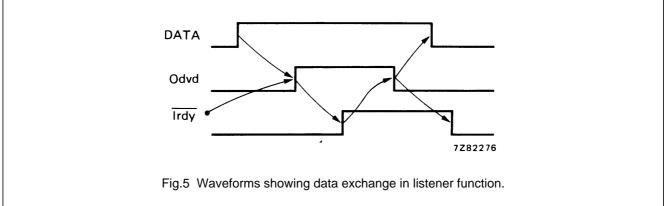
### **DC CHARACTERISTICS**

		V <sub>OL</sub> V	V <sub>он</sub> V	SYMBOL	T <sub>amb</sub> (°C)						
	V <sub>DD</sub> V				-40		+ 25		+ 85		
					MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Output current	5		2,5		3		2,5		2,0		mA
HIGH; see note	5		4,6	–I <sub>OH</sub>	1		0,85		0,65		mA
	10		9,5		3		2,5		2,0		mΑ
Output current	4,75	0,4		I <sub>OL</sub>	2,7		2,3		1,8		mA
LOW; see note	10	0,5			9,5		8,0		6,3		mA
Quiscent device	5					50		50		375	μΑ
current	10			I <sub>DD</sub>		100		100		750	μA

### Note

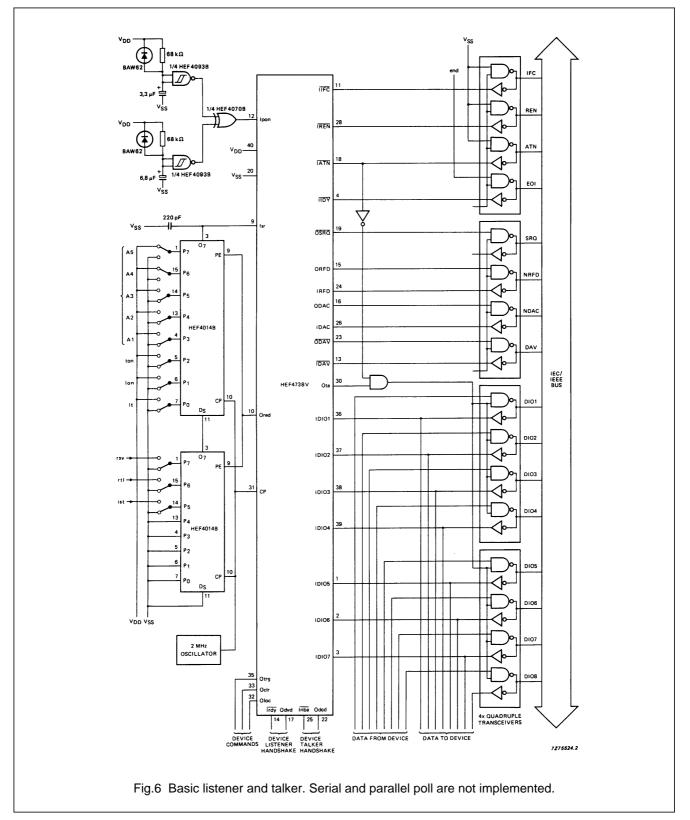
1. Output currents for pins: 5 = OPP, 6 = OP3, 7 = OP2, 8 = OP1, 15 = ORFD, 16 = ODAC; 19 =  $\overline{OSRQ}$ , 23 =  $\overline{ODAV}$ . These pins can drive one standard TTL load.





HEF4738V LSI

#### **APPLICATION INFORMATION**



This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.